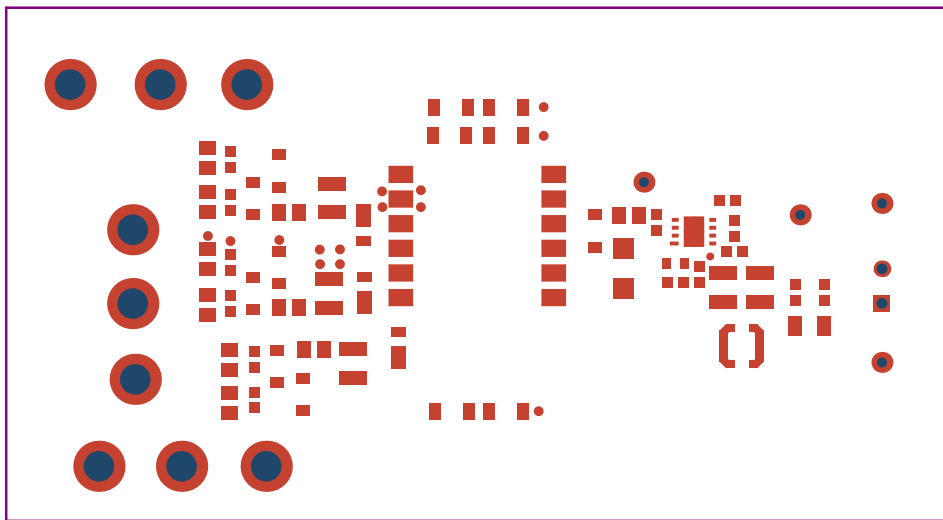
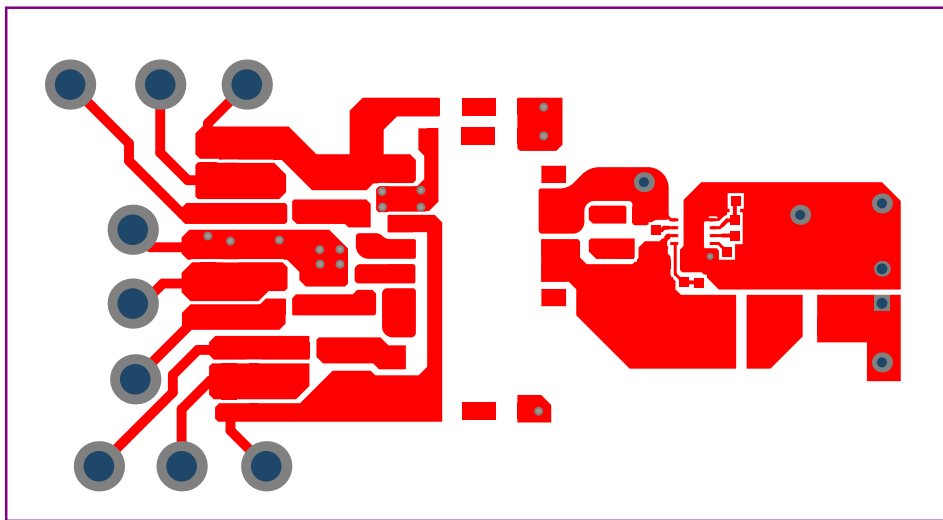


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: [No Variations]

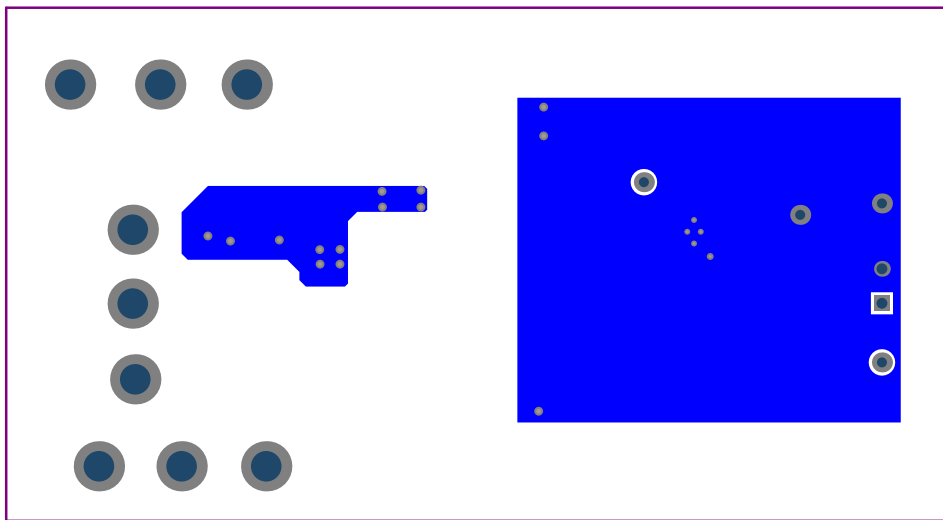
ACB NETWORK FOR WIDF SIDE TOP SIDE	BOARD #: PMP30934	REV: A	SUN REV: Not in version control
LAYER NAME = M1 Board Outline	TID #: N/A		
PLOT NAME = Assembly	GENERATED : 4/4/2022 18:42:59	TEXAS INSTRUMENTS	



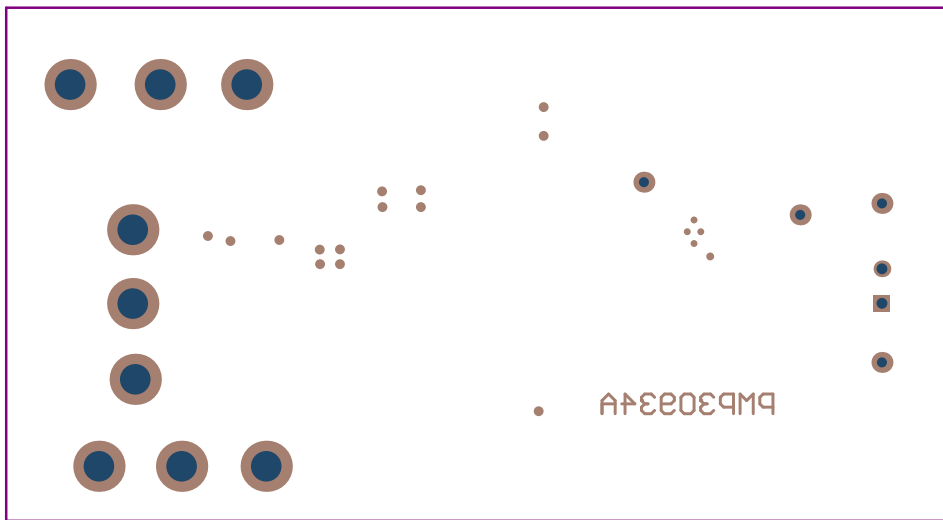
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP30934	REV: A	SUN REV: Not in version control
LAYER NAME = Top Solder	TID #: N/A		
PLOT NAME = Top Solder Mask	GENERATED : 4/4/2022 18:42:59	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP30934	REV: A	SUN REV: Not in version control
LAYER NAME = Top Layer	TID #: N/A		
PLOT NAME = Top Layer	GENERATED : 4/4/2022 18:43:00	TEXAS INSTRUMENTS	

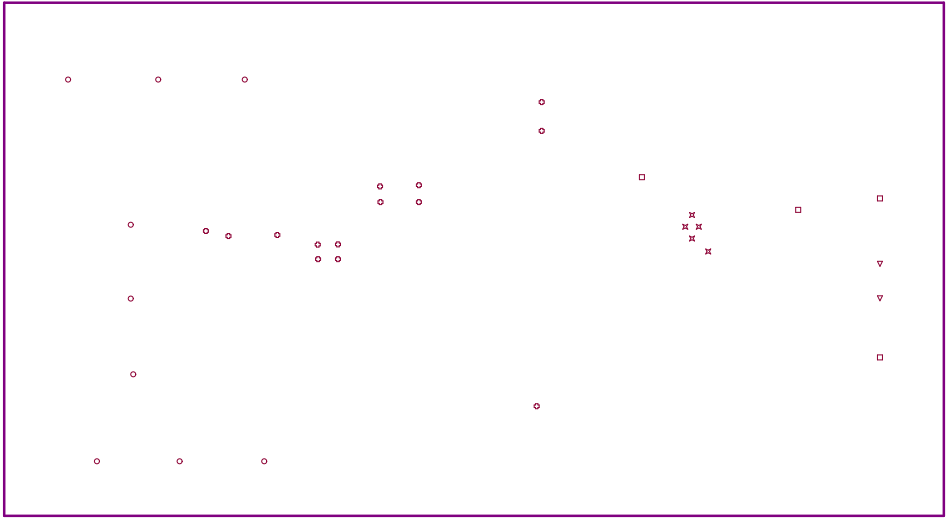


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP30934	REV: A	SUN REV: Not in version control
LAYER NAME = Bottom Layer	TID #: N/A		
PLOT NAME = Bottom Layer	GENERATED : 4/4/2022	18:43:00	TEXAS INSTRUMENTS

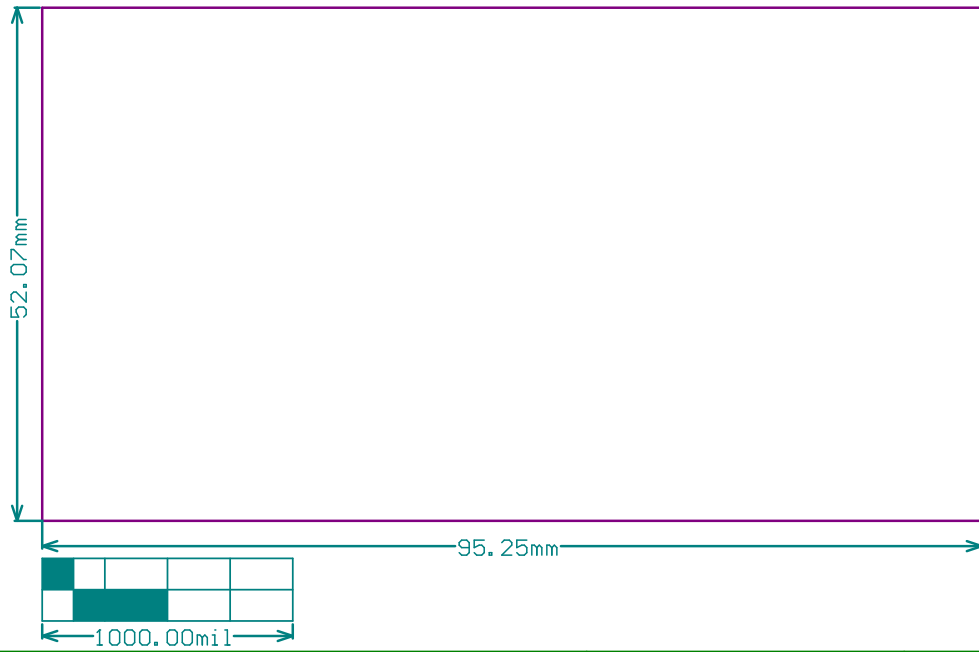


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP30934	REV: A	SUN REV: Not in version control
LAYER NAME = Bottom Solder	TID #: N/A		
PLOT NAME = Bottom Solder Mask	GENERATED : 4/4/2022	18:43:00	TEXAS INSTRUMENTS

Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
✕	5	11.81mil (0.300mm)	PTH	Round	Top Layer - Bottom Layer	
⊕	14	19.69mil (0.500mm)	PTH	Round	Top Layer - Bottom Layer	
□	4	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	
▽	2	43.31mil (1.100mm)	PTH	Round	Top Layer - Bottom Layer	
○	9	122.05mil (3.100mm)	PTH	Round	Top Layer - Bottom Layer	
	34 Total					



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP30934	REV: A	SUN REV: Not in version control
LAYER NAME = Drill Drawing	TID #: N/A		
PLOT NAME = Drill Drawing	GENERATED : 4/4/2022	18:43:00	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP30934	REV: A	SUN REV: Not in version control
LAYER NAME = M2 Board Dimensions	TID #: N/A		
PLOT NAME = Board Dimensions	GENERATED : 4/4/2022 18:43:00	TEXAS INSTRUMENTS	

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